

	Hits	Search Text	DBs	Time Stamp
1	391	self adj assembled adj monolayer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
2	156420	pyridine pyridinium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
3	79	(self adj assembled adj monolayer) and (pyridine pyridinium)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
4	55	((self adj assembled adj monolayer) and (pyridine pyridinium)) and (semiconductor silicon Si)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:34
5	99	linford.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:35
6	4	(matthew and linford).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:48
7	5	5429708.URPN.	USPAT	2002/07/17 18:42
8	125110 2	(silicon si) near5 bond\$3 (organic molecule molecules)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:53
9	148885 1	(silicon si) near5 bond\$3 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:01
10	198231	(silicon si) near2 (surface substrate wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:01
11	9555	(silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:13
12	896	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:14
13	143	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular))) and barrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:02
14	26	((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular)) same barrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:03
15	422	(silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:16
16	130	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic molecule molecules molecular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:17
17	223	(silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic organo)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:16
18	49	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic organo))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:17
19	0	5770266.URPN.	USPAT	2002/07/17 19:22
20	0	5770266.URPN.	USPAT	2002/07/17 19:23
21	4	5468551.URPN.	USPAT	2002/07/17 19:23
22	4	5849369.URPN.	USPAT	2002/07/17 19:24
23	2	5907013.URPN.	USPAT	2002/07/17 19:25
24	2	5907013.URPN.	USPAT	2002/07/17 19:26

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25	0	6280517.URPN.	USPAT	2002/07/17 19:26
26	0	6060123.URPN.	USPAT	2002/07/17 19:26
27	0	6060123.URPN.	USPAT	2002/07/17 19:26
28	1	6033774.urpn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 11:04
29	2	6033774.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 11:04
30	1	"5317657".PN.	USPAT	2002/07/18 11:04
31	1	"5156918".PN.	USPAT	2002/07/18 11:04
32	12	5156918.URPN.	USPAT	2002/07/18 11:05
33	0	5871815.URPN.	USPAT	2002/07/18 11:10
34	0	5871815.URPN.	USPAT	2002/07/18 11:10
35	1	5648201.URPN.	USPAT	2002/07/18 11:13
36	1	"4935292".PN.	USPAT	2002/07/18 11:14
37	1	"4900127".PN.	USPAT	2002/07/18 11:14
38	1	"4886339".PN.	USPAT	2002/07/18 11:14
39	1	"4877298".PN.	USPAT	2002/07/18 11:14
40	1	"4828758".PN.	USPAT	2002/07/18 11:15
41	1	"4818616".PN.	USPAT	2002/07/18 11:15
42	1	"4807968".PN.	USPAT	2002/07/18 11:15
43	1	"4796971".PN.	USPAT	2002/07/18 11:15
44	1	"4792208".PN.	USPAT	2002/07/18 11:15
45	1	"4779961".PN.	USPAT	2002/07/18 11:15
46	1	"4539061".PN.	USPAT	2002/07/18 11:15
47	121	4539061.URPN.	USPAT	2002/07/18 11:16
48	15	4715929.URPN.	USPAT	2002/07/18 11:18
49	7	4945028.URPN.	USPAT	2002/07/18 11:22
50	4	5645633.URPN.	USPAT	2002/07/18 11:23
51	0	5770640.URPN.	USPAT	2002/07/18 11:25
52	0	5770640.URPN.	USPAT	2002/07/18 11:25

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53	2	6063438.URPN.	USPAT	2002/07/18 11:25
54	4	4960722.URPN.	USPAT	2002/07/18 11:27
55	9	4996075.URPN.	USPAT	2002/07/18 11:28
56	13	5057339.URPN.	USPAT	2002/07/18 11:31
57	0	5246740.URPN.	USPAT	2002/07/18 11:33
58	0	5246740.URPN.	USPAT	2002/07/18 11:33
59	25	5077085.URPN.	USPAT	2002/07/18 12:01
60	5	5389496.URPN.	USPAT	2002/07/18 12:08
61	85	5079600.URPN.	USPAT	2002/07/18 12:14
62	11	5468597.URPN.	USPAT	2002/07/18 12:23
63	4	5500315.URPN.	USPAT	2002/07/18 12:30
64	5	5510216.URPN.	USPAT	2002/07/18 12:32
65	4	5093154.URPN.	USPAT	2002/07/18 13:00
66	3	5389496.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 16:28
67	3	5079600.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 16:29